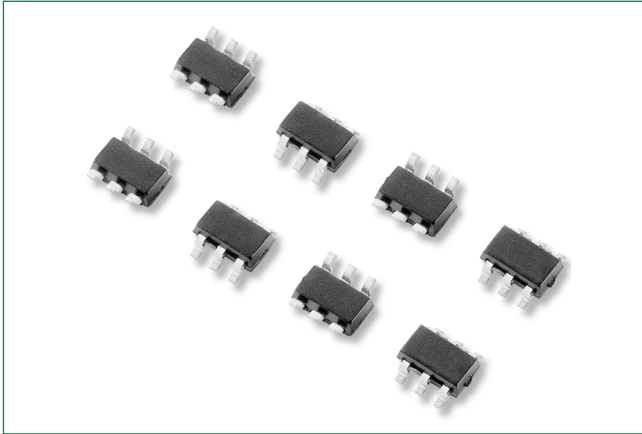
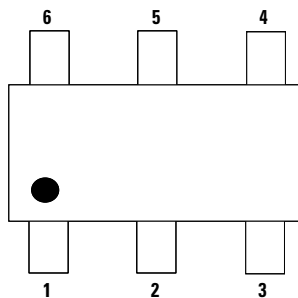


SP3019 Series

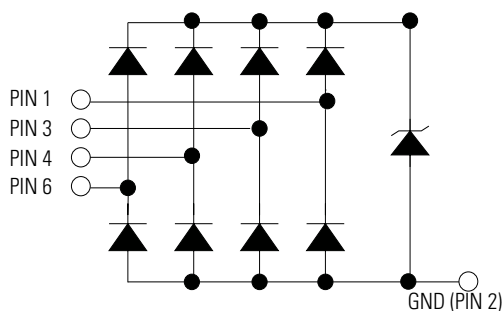
Low Capacitance ESD Protection



Pinout



Functional Block Diagram



Note: PIN 5 is NC

Description

The SP3019 integrates 4 channels of ultra low capacitance asymmetrical protection for electronic equipment that may experience destructive electrostatic discharges (ESD). These robust components can safely absorb repetitive ESD strikes above the maximum contact level specified in IEC 61000-4-2 (± 8 kV contact discharge) without performance degradation.

The extremely low off-state capacitance also makes it ideal for protecting high speed signal lines such as USB3.0, HDMI, USB2.0, and eSATA.

Features & Benefits

- ESD, IEC 61000-4-2, ± 10 kV contact, ± 15 kV air
- EFT, IEC 61000-4-4, 40A (tp=5/50ns)
- Lightning, IEC 61000-4-5 2nd Edition, 2.5A (tp=8/20us)
- Low capacitance of 0.3pF @0V, 3GHz (TYP) per I/O
- Low leakage current of 10nA (TYP) at 5V
- AEC-Q101 qualified
- Moisture Sensitivity Level (MSL -1)
- Halogen free, lead free and RoHS compliant
- PPAP capable

Applications

- LCD/PDP TVs
- External Storages
- DVD/Blu-ray Players
- Desktops
- MP3/PMP
- Set Top Boxes
- Smartphones
- Ultrabooks/Notebooks
- Digital Cameras

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

SP3019 Series

Low Capacitance ESD Protection

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I_{PP}	Peak Current ($t_p=8/20\mu s$)	2.5	A
T_{OP}	Operating Temperature	-40 to 125	°C
T_{STOR}	Storage Temperature	-55 to 150	°C

Caution: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

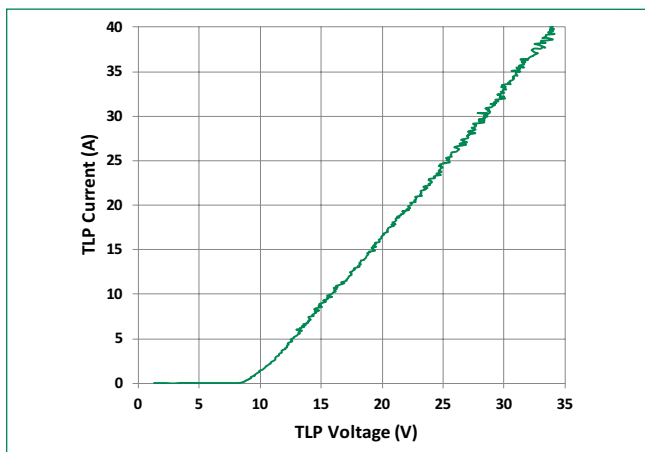
Electrical Characteristics ($T_{OP}=25^{\circ}C$)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V_{RWM}	$I_R \leq 1\mu A$			5.0	V
Reverse Leakage Current	I_{LEAK}	$V_R=5V$, Any I/O to GND		0.01	0.50	μA
Breakdown Voltage	V_{BR}	$I_R=1mA$		8.2		V
Clamp Voltage ¹	V_C	$I_{PP}=1A$, $t_p=8/20\mu s$, Fwd		10.5		V
		$I_{PP}=2A$, $t_p=8/20\mu s$, Fwd		11.5		V
Dynamic Resistance ²	R_{DYN}	TLP, $t_p=100ns$, I/O to GND		0.64		Ω
ESD Withstand Voltage ¹	V_{ESD}	IEC 61000-4-2 (Contact)	+/- 10			kV
		IEC 61000-4-2 (Air)	+/- 15			kV
Diode Capacitance ¹	$C_{I/O-GND}$	Reverse Bias=0V, $f=3GHz$		0.3		μF
	$C_{I/O-I/O}$			0.18		

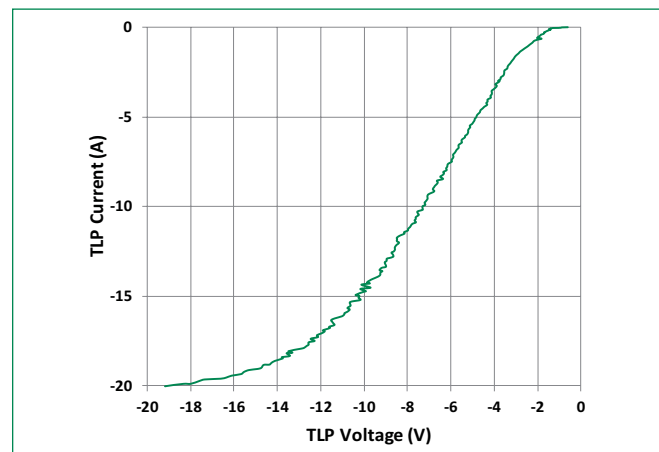
Note:

- Parameter is guaranteed by design and/or component characterization.
- Transmission Line Pulse (TLP) with 100ns width, 2ns rise time, and average window $t_1=70ns$ to $t_2=90ns$

Positive Transmission Line Pulsing(TLP) Plot



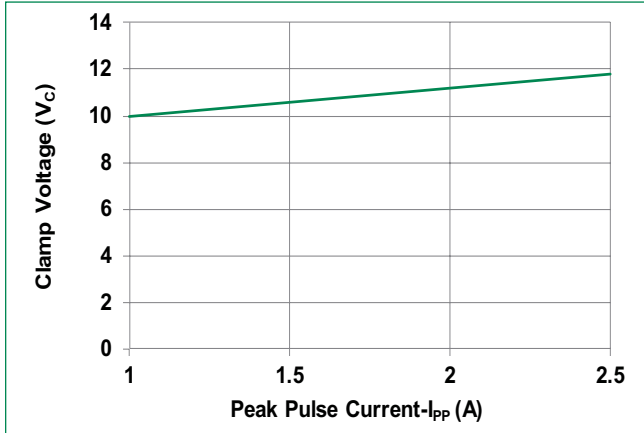
Positive Transmission Line Pulsing(TLP) Plot



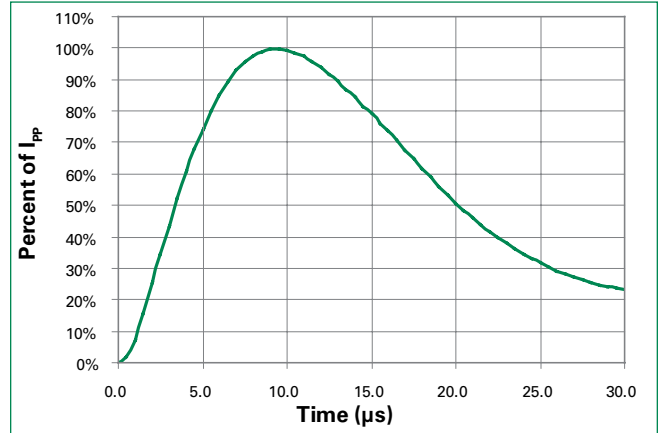
SP3019 Series

Low Capacitance ESD Protection

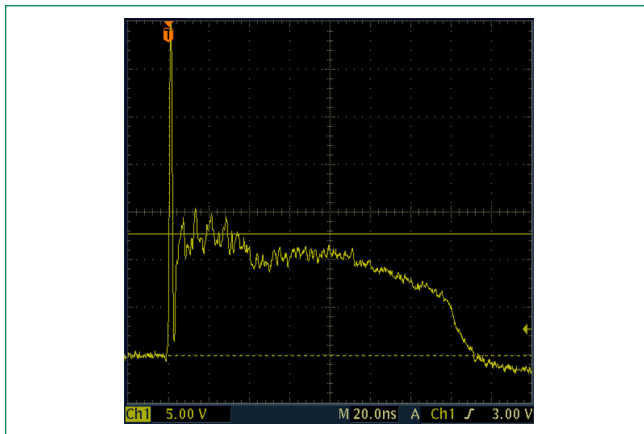
Clamping Voltage vs. IPP for 8/20µs Waveshape



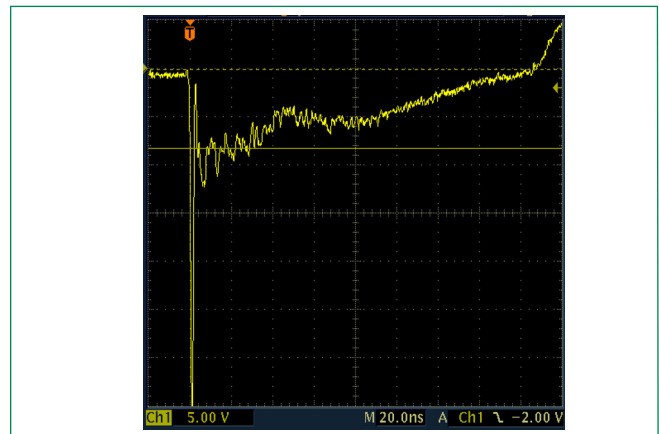
8/20 µs Pulse Waveform



IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage



IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage

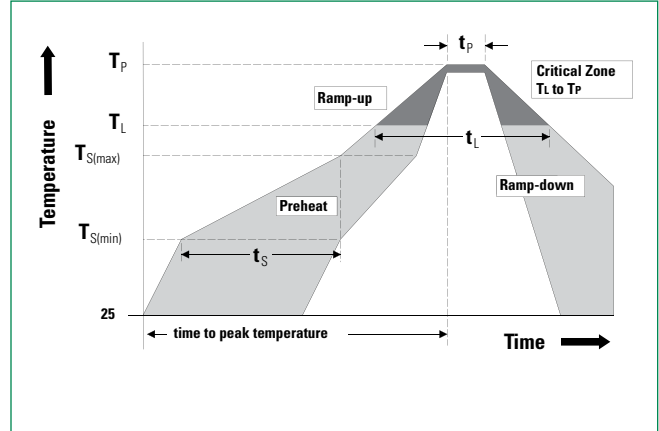


SP3019 Series

Low Capacitance ESD Protection

Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_p)	60 – 120 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



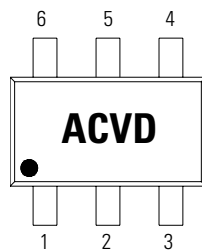
Ordering Information

Part Number	Package	Min. Order Qty.
SP3019-04HTG	SOT23-6	3000

Product Characteristics

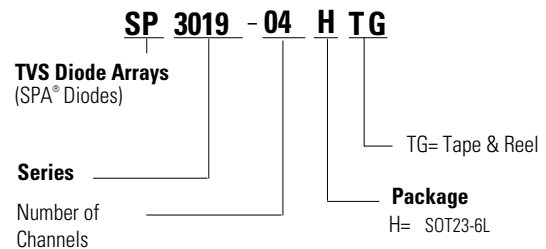
Lead Plating	Matte tin
Lead Material	Copper Alloy
Lead Coplanarity	0.0004 inches (0.102mm)
Substrate material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

Part Marking System



AC : Part code
V : Assembly code
D : Date code

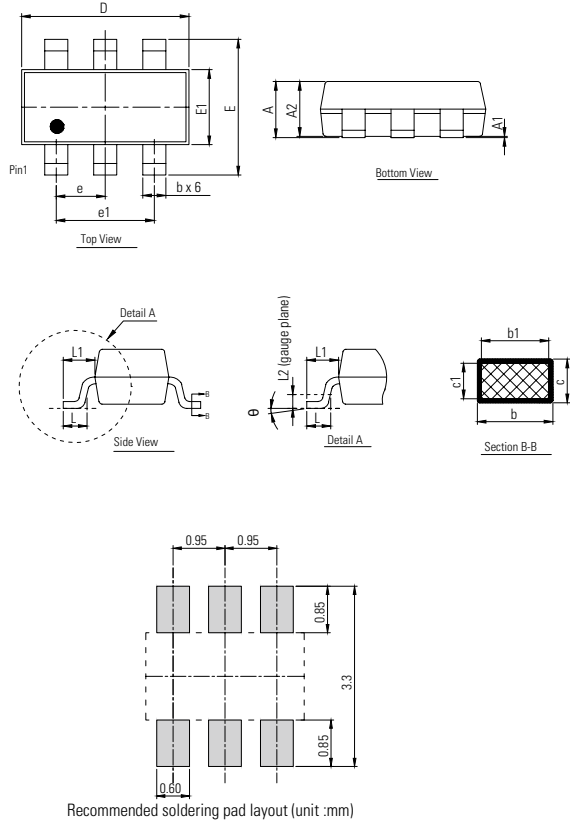
Part Numbering System



SP3019 Series

Low Capacitance ESD Protection

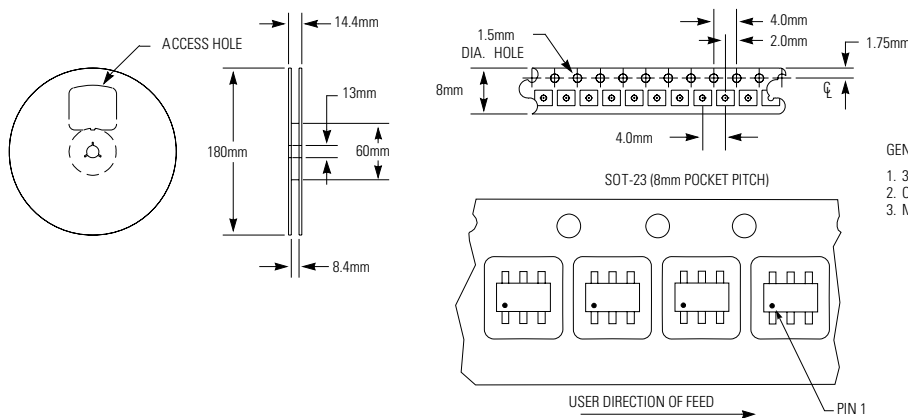
Package Dimensions – SOT23-6L



Symbol	Millimeters		
	Min	Nom	Max
A	-	-	1.45
A1	0.00	-	0.15
A2	0.90	1.15	1.30
b	0.25	-	0.50
b1	0.25	0.40	0.45
c	0.08	-	0.22
c1	0.08	0.13	0.20
D	2.75	2.90	3.05
E	2.60	2.80	3.00
E1	1.45	1.60	1.75
e	0.95 BSC		
e1	1.90 BSC		
L	0.30	0.50	0.60
L1	0.60 REF		
L2	0.25 BSC		
θ	0°	4°	8°

Embossed Carrier Tape & Reel Specification – SOT23-6L

8mm TAPE AND REEL



Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at <http://www.littelfuse.com/disclaimer-electronics>.